Effective September 2020

STS232120U901 TVS Diode array ESD suppressor



Product features

- 500 watts peak pulse power per line (t_P=8/20 µs)
- Protects two I/O lines with uni-directional
- Low clamping voltage
- Working voltage:12 V
- Low leakage current
- Meets moisture sensitivity level (MSL) 3
- Molding compound flammability rating: UL 94V-0
- Termination finish:Tin

Applications

- RS-232, RS-422 & RS-485
- Servers, notebook, and desktop
- Cellular handsets and accessories
- Control & amp; monitoring systems

BUSSMANN SERIES

- Portable electronics
- · Wireless bus protection
- Set-top box

Environmental compliance and general specifications

- IEC61000-4-2 (ESD)
 - ±30 kV (air)
 - ±30 kV (contact)
- IEC61000-4-5 (Lightning) 20 A (8/20 μs)



Ordering part number



Pin out/functional diagram



SOT-23



Pin Configuration



Absolute maximum ratings

(+25 °C, RH=45%-75%, unless otherwise noted)

Symbol	Value	Unit
Ppp	500	W
V _{ESD}	+/-30	kV
	+/-30	
T	+260 (10 seconds)	°C
Tj	-55 to +125	°C
T _{stg}	-55 to +150	°C
	P _{pp} V _{ESD} T _L T _J T	P _{pp} 500 V _{ESD} +/-30 +/-30 +/-30 T _L +260 (10 seconds) T _J -55 to +125 T 55 to +125

Electrical characteristics

(+25 °C)

ST	S232120U901	
-	-	

Parameter	Test condition	Minimum	Typical	Maximum	Symbol (Units)
Reverse working voltage	-	-	-	12	V _{RWM} (V)
Reverse breakdown voltage	I _T = 1 mA	13	-	-	V _{BR} (V)
Reverse leakage current	V _{RWM} = 12 V	-	-	0.15	Ι _в (μΑ)
Clamping voltage	I _{pp} = 1 A,	-	14	18	V _c (V)
	t _p = 8/20 μs				
	I _{pp} = 20 A,	-	23	26	V _c (V)
	t _p = 8/20 μs				
Junction capacitance	V _{RWM} = 0 V, f = 1 MHz	-	90	-	С _J (рF)*
	Any I/O pin to GND				
	V _{RWM} = 0 V, f = 1 MHz	-	45	-	C _J (pF)**
	Between I/O pins				

* $C_{,1}$ measured at VRWM = 0 V, 1 MHz (pin1 to pin3, pin2 to pin3).

**C, measured at VRWM = 0 V, 1 MHz (pin1 to pin2, pin2 to pin1).

Mechanical parameters, pad layout- mm/inches



Land Pattern

	Millimeters		Inches	
Dimension	Minimum	Maximum	Minimum	Maximum
A	0.90	1.15	0.035	0.045
A1	0.00	0.10	0.000	0.004
b	0.25	0.325	0.010	0.013
С	0.22	0.25	0.009	0.010
D	2.80	3.00	0.110	0.118
е	1.80	1.90	0.071	0.075
E	1.20	1.40	0.047	0.055
L	0.30	0.50	0.012	0.020
He	2.25	2.55	0.089	0.100
Х	0.80		0.031	
X1	0.95		0.037	
Y	0.80		0.031	
Z	2.02		0.080	

Part marking



STS232120U901 TVS Diode array ESD suppressor

Packaging information mm/inches

Drawing not to scale.

Supplied in tape and reel packaging, 3,000 parts per 7" diameter reel (EIA-481 compliant)



Pin 1 quadrant: Q3

Cumhel	Millimeters	Inches
Symbol	Тур.	Тур.
А	3.15	0.124
в	2.77	0.109
С	1.22	0.048
d	Φ1.50	Ф0.059
E	1.75	0.069
F	3.50	0.138
P0	4.00	0.157
Р	4.00	0.157
P1	2.00	0.079
W	8.00	0.315
D	Φ178	Φ7.008
D1	54.40	2.142
D2	13.00	0.512
G	R78.00	R3.071
н	R25.60	R1.008
I	R6.50	R0.256
W1	9.50	0.374
W2	12.30	0.484

Ratings and V-I characteristic curves (+25 °C unless otherwise noted)

V- I curve characteristics (Uni-directional)



Pulse derating curve



Pulse waveform (8/20 µs)



ESD waveform



STS232120U901 TVS Diode array ESD suppressor

Solder reflow profile



Table 1 - Standard SnPb solder (T_c)

C Package thickness	Volume mm3 <350	Volume mm3 ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2 - Lead (Pb) free solder (T_c)

Package thickness	Volume mm ³ <350	Volume mm³ 350 - 2000	Volume mm ³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 – 2.5 m	im 260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

Reference J-STD-020

Powering Business Worldwide

Profile feature	Standard SnPb solder	Lead (Pb) free solder
Preheat and soak • Temperature min. (T _{smin})	100 °C	150 °C
• Temperature max. (T _{smax})	150 °C	200 °C
• Time (T _{smin} to T _{smax}) (t _s)	60-120 seconds	60-120 seconds
Ramp up rate TL to Tp	3 °C/ second max.	3 °C/ second max.
Liquidous temperature (TL) Time (tL) maintained above ${\rm T_L}$	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak package body temperature (T _P)*	Table 1	Table 2
Time $(t_p)^*$ within 5 °C of the specified classification temperature (T_c)	20 seconds*	30 seconds*
Ramp-down rate (Tp to TL)	6 °C/ second max.	6 °C/ second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

 * Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

Life Support Policy: Eaton does not authorize the use of any of its products for use in life support devices or systems without the express written approval of an officer of the Company. Life support systems are devices which support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.

Eaton reserves the right, without notice, to change design or construction of any products and to discontinue or limit distribution of any products. Eaton also reserves the right to change or update, without notice, any technical information contained in this bulletin.

Eaton

Electronics Division 1000 Eaton Boulevard Cleveland, OH 44122 United States Eaton.com/electronics

© 2020 Eaton All Rights Reserved Printed in USA Publication No. 11156 BU-MC20138 September 2020

Eaton is a registered trademark.

All other trademarks are property of their respective owners.

Follow us on social media to get the latest product and support information.

